REVISIONS DATE DESCRIPTION **APPROVED** LTR 18 NOV. Add vendor CAGE 01295 to case out-RREvans lines O1RX and O12X and add vendor CAGE 27014 to case outline 012X. Convert to military drawing format. Changed Code Ident. No. to 67268. **CURRENT CAGE CODE 67268** REV PAGE Α Α REV **REV STATUS** OF PAGES 10 **PAGES** 8 11 2 3 ITARY DRAWING PREPARED BY, **Defense Electronics Supply Center** This drawing is available for use by all Departments and Agencies of the Dayton, Ohio CHECKED Department of Defense TITLE: MICROCIRCUIT, DIGITAL, HIGH SPEED CMOS, THREE-STATE OCTAL LATCH, Original date MONOLITHIC SILICON of drawing: 10 DECEMBER 1985 CODE IDENT. NO. DWG NO. 85128 14933 REV AMSC N/A Α PAGE **OF** 13

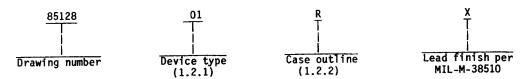
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- $1.1\,$ Scope. This drawing describes device requirements for class B microcircuits in accordance with $1.\overline{2.1}$ of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices".
 - 1.2 Part number. The complete part number shall be as shown in the following example:



1.2.1 Device type. The device type shall identify the circuit function as follows:

Device type	Generic number	Circuit function
01	54HC573	Octal D-type latch with three-state outputs

1.2.2 <u>Case outlines</u>. The case outlines shall be as designated in appendix C of MIL-M-38510, and as follows:

Outline letter	<u>Case outline</u>			
R	D-8 (20-lead, 1/4" x 1 1/16"),			
2	dual-in-line package C-2 (20-terminal, .350" x .350"), square chip carrier package			

1.3 Absolute maximum ratings. 1/

Supply voltage range	-0.5 V dc to 7 V dc
Supply voltage range	0 F V do to V +0 F V do
DC input voltage	-0.5 y dc to ycc lo.5 y dc
DC output voltage	-0.5 V dc to V _{CC} +0.5 V dc -0.5 V dc to V _{CC} +0.5 V dc
Clamp diode current (I_{IK} , I_{OK})	±20 mA
Clamb diode current (IIK; 10K)	±35 mA
DC output current (per pin)	
DC VCC or GND current (per pin)	±70 mA
DC ACC OF GND current (ber bin) =	-65°C to +150°C
Storage temperature range	
Maximum power dissipation (P _D) $\frac{2}{-}$	500 mW
maximum power dissipation (PD) 2/	
Lead temperature (soldering, 10 seconds)	+260°C
Ledu temperature (Solder 135) to sold (G.)	
Thermal resistance, junction-to-case (0jc)	
Case R	See MIL-M-38510, appendix C
case k	+175°C
Junction temperature (T _J)	*1/5 C

1/ Unless otherwise specified, all voltages are referenced to ground. Z/ For T_C = +100 $^{\circ}$ C to +125 $^{\circ}$ C, derate linearly at 12 mW/ $^{\circ}$ C.

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Recommended operating conditions.
+2.0 V dc to +6.0 V dc -55°C to +125°C
                                  0 to 1000 ns
                                  0 to 500 ns
0 to 400 ns
Minimum setup time (t_S):
  T_C = +25^{\circ}C
      75 ns
                                  15 ns
  110 ns
                                  22 ns
Minimum hold time (t_H):
   T_C = +25^{\circ}C
      5 ns
   T_C = -55°C to +125°C
      45 ns
                                  9 ns
Minimum pulse width (tw):
   T_C = +25^{\circ}C
      16 ns
                                  14 ns
   T_{C} = -55^{\circ}C \text{ to } +125^{\circ}C
      24 ns
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2. APPLICABLE DOCUMENTS

2.1 <u>Government specification and standard</u>. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510

- Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883

Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

- 2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.
 - REQUIREMENTS
- 3.1 <u>Item requirements</u>. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.
- 3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.
 - 3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.
 - 3.2.2 Logic diagram. The logic diagram shall be as specified on figure 2.
 - 3.2.3 Truth table. The truth table shall be as specified on figure 3.
 - 3.2.4 Switching waveforms. The switching waveforms shall be as specified on figure 4.
 - 3.2.5 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.
- 3.3 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I and apply over the full recommended case operating temperature range.
- 3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.4 herein.
- 3.5 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.4. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.

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	TABLE	I. Electr	ical performan	ce characteristi	cs.				
Test	Symbol	l un1	Conditions -55°C < T _C < + ess otherwise	1/ 125°C specified	Group A subgroups	Limi Min	J	Unit	
High level output voltage	I V _{OH}	 Λ ^{IM} = Λ ^{IH}		V _{CC} = 2.0 V	1,2,3	1.9		٧	
	I ₀ <u><</u> 20 	μА	V _{CC} = 4.5 V	- -	4.4 5.9				
	1		· · · · · · · · · · · · · · · · · · ·	$V_{CC} = 6.0 \text{ V}$ $V_{CC} = 4.5 \text{ V}$	_	3.7			
	 	$ I_0 < 6.$	O mA			3.7			
	 	$V_{IN} = V_{IH}$	or V _{IL} 8 mA	V _{CC} = 6.0 V	 	5.2] 		
Low level output voltage	V _{OL}	i AIN = AIH	or V _{IL}	V _{CC} = 2.0 V		 	0.1	٧	
vorcage	İ	I ₀ < 20	μΑ	V _{CC} = 4.5 V	1,2,3		0.1	<u> </u>	
		<u> </u> 		V _{CC} = 6.0 V		l l	0.1	 	
		$V_{IN} = V_{IH}$	or V _{IL} O mA	V _{CC} = 4.5 V		!	0.4	 -	
	 	$\frac{V_{IN} = V_{IH}}{ I_C \leq 7}$	or V _{IL} 8 mA	V _{CC} = 6.0 V	-		0.4	1 	
High level input voltage 2/	VIH			V _{CC} = 2.0 V		1.5	Ì	 V 	
vo. tage <u>r</u> ,	i	i i		V _{CC} = 4.5 V	1,2,3	3.15	1	 	
	<u> </u>	 		V _{CC} = 6.0 V		4.2		<u> </u>	
Low level input voltage 2/	VIL	! ! !		V _{CC} = 2.0 V			0.3		
vorcage <u>z</u> /		i		V _{CC} = 4.5 V	1,2,3	1	1 0.9	į v	
		<u> </u> 		V _{CC} = 6.0 V			1.2	<u> </u>	
Input capacitance	C _{IN}	V _{IN} = 0 \ See 4.3.1	/, T _C = +25°C		4	 	10	pF	
Quiescent current	ICC	V _{CC} = 6.0	V or GND		1,2,3		160	 μ A 	
Input leakage current	IIN	V _{CC} = 6.0) V ; or GND		1,2,3		±1	 μΑ	
See footnotes at end	of table.								
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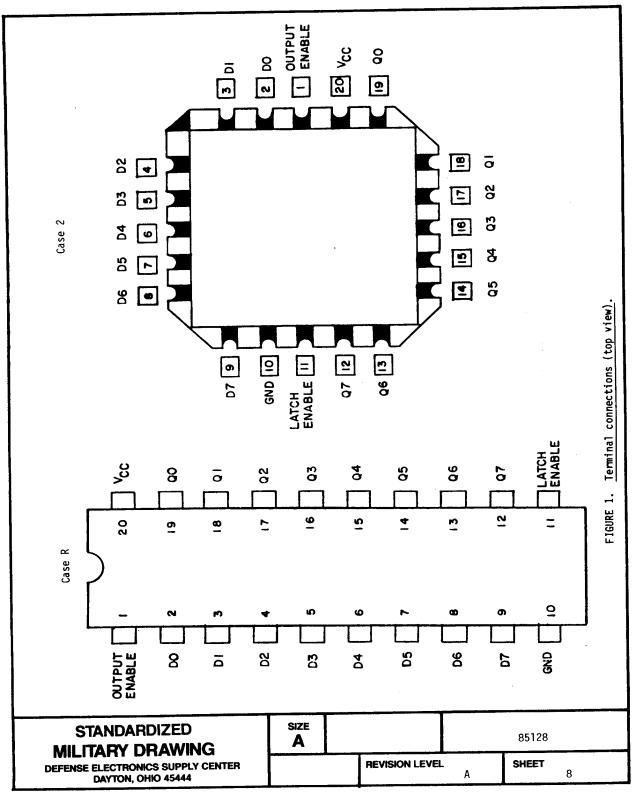
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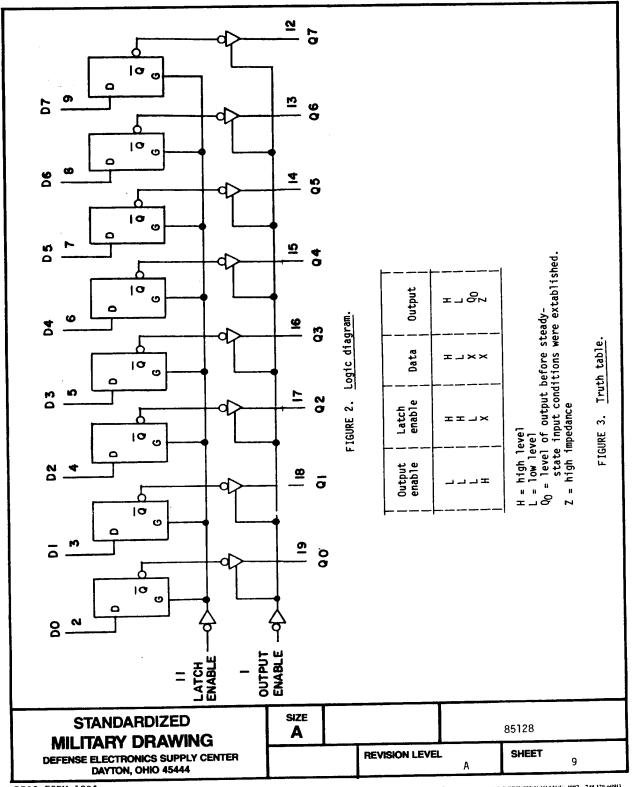
Test	Symbol		Conditio	ns 1/	Group A	Lim	its	Unit
		-55°C < T _C < +125°C unless otherwise specified		subgroups	Min	Max		
Three-state output leakage current	I _{OZ}	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	or GND or V _{IL}		1,2,3		±10 	μA
Output capaci- tance	c _{out}	See 4.3.1d	C		4		20	pF
Functional tests		See 4.3.1	d 		7			
Propagation delay time, data to	t _{PHL1}	T _C = +25°	С	V _{CC} = 2.0 V	9		175	l ns
Q output (see fig. 4)	t _{PLH1}	C _L = 50 pl	F ±10%	V _{CC} = 4.5 V	_		35	
(see 11g. +/				V _{CC} = 6.0 V			30	
		$T_C = -55^\circ$	C, +125°C	V _{CC} = 2.0 V	10, 11		265	!
		C _L = 50 p	F ±10%	$V_{CC} = 4.5 \text{ V}$	_		53	İ
	! 			V _{CC} = 6.0 V	<u></u>		45 	! !
Propagation delay	tpHL2	T _C = +25°	С	V _{CC} = 2.0 V	9		175	ns
time, latch	 t _{PLH2}	C _L = 50 p	F ±10%	$V_{CC} = 4.5 \text{ V}$		 	35	•
				V _{CC} = 6.0 V			30	j
	<u> </u>	$T_C = -55^\circ$	C, +125°C	V _{CC} = 2.0 V	10, 11	 	265	
	 	C _L = 50 p	F ±10%	V _{CC} = 4.5 V	_		53	
	! 	1		V _{CC} = 6.0 V	- <u> </u>	i	45	
Propagation delay	t _{PZH}	T _C = +25°	С	V _{CC} = 2.0 V	9		175	ns
time, output enable to any	tpZL	C _L = 50 p	F ±10%	$V_{CC} = 4.5 \text{ V}$		ļ	35	
output (see fig. 4)	1			$V_{CC} = 6.0 \text{ V}$	_		30	
		T _C = -55°	°C, +125°C	V _{CC} = 2.0 V	10, 11		265	
		C _L = 50 p	F ±10%	$V_{CC} = 4.5 \text{ V}$	_		53	į
				$V_{CC} = 6.0 \text{ V}$		i	45	j
See footnotes at end	l of table.							-
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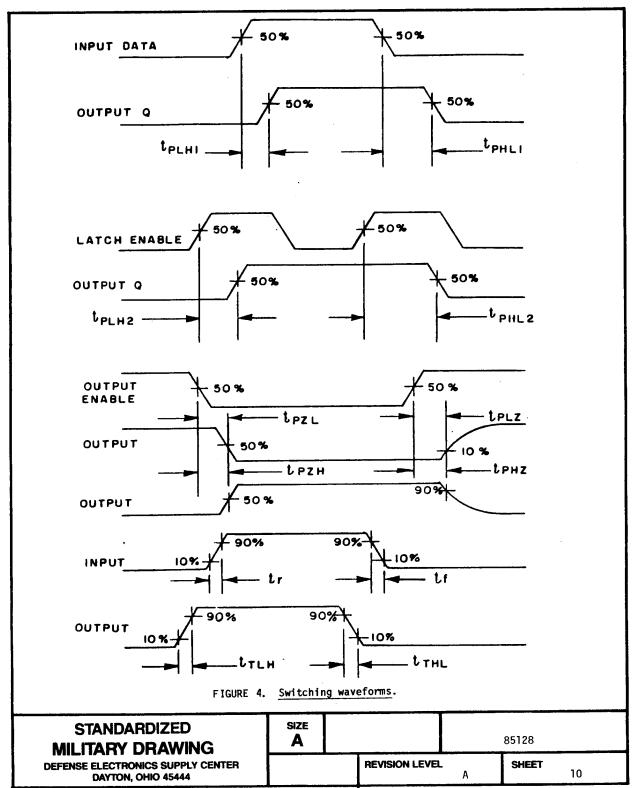
	TABLE I. E	lectrical performance c	haracteristics - (Continued.		_	
Test Symbol		Condition	Group A	Lim	its	Unit	
	i !	-55°C < T _C < unless otherwis	+12 5 °C	subgroups	Min	Max	
Propagation delay time, output	tpHZ	T _C = +25°C	V _{CC} = 2.0 V	9		175	l l ns
disable to any output 3/	t _{PLZ}	C _L = 50 pF ±10%	V _{CC} = 4.5 V	-		35	İ
(see fig. 4)			$V_{CC} = 6.0 \text{ V}$			30	İ
		T _C = -55°C, +125°C	V _{CC} = 2.0 V	10, 11		265	
		CL = 50 pF ±10%	V _{CC} = 4.5 V	_		53	
	! [[$V_{CC} = 6.0 \text{ V}$			45	
Transistion time	tTHL	T _C = +25°C	V _{CC} = 2.0 V	9		60	ns
output rise and fall 4/	tTLH	C _L = 50 pF ±10%	V _{CC} = 4.5 V	_		12	
(see fTg. 4)			$V_{CC} = 6.0 \text{ V}$	_		10	
		T _C = -55°C, +125°C	V _{CC} = 2.0 V	10, 11		90	
		C _L = 50 pF ±10%	V _{CC} = 4.5 V			18	! ! !
			V _{CC} = 6.0 V	_		15	

- For a power supply of 5 V $\pm 10\%$, the worst case output voltages (V_{OH} and V_{OL}) occur for HC at 4.5 V. Thus, the 4.5 V values should be used when designing with this supply. Worst case VIH and VIL occur at V_{CC} = 5.5 V and 4.5 V, respectively. (The VIH value at 5.5 V is 3.85 V.) The worst case leakage currents (IIN, I_{CC}, and I_{QZ}) occur for CMOS at the higher voltage so the 6.0 V values should be used. Power dissipation capacitance (C_{PD}), typically 50 pF, determines the no load dynamic power consumption, P_D = C_{PD} V_{CC}2 f⁺¹CC V_{CC}, and the no load dynamic current consumption, I_S = C_{PD} V_{CC} f⁺¹CC.
- $\underline{2}/$ V_{IL} and V_{IH} tests not required if applied as forcing function for V_{OH} and V_{OL}.
- 3/ Propagation delay times at $V_{CC} = 2.0 \text{ V}$, $V_{CC} = 6.0 \text{ V}$ shall be guaranteed if not tested.
- 4/ Transistion times, if not tested, shall be guaranteed to the specified parameters.

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- 3.6 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.
- 3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).
- 3.8 <u>Verification and review</u>. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
 - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).
- 4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
 - a. Burn-in test (method 1015 of MIL-STD-883).
 - Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_{\Lambda} = +125^{\circ}C$, minimum.
 - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.
- 4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
 - 4.3.1 Group A inspection.
 - a. Tests shall be as specified in table II herein.
 - b. Subgroups 5, 6, and 8 in table I, method 5005 of MIL-STD-883 shall be omitted.
 - c. Subgroup 4 ($C_{\rm IN}$ or $C_{\rm OUT}$ measurement) shall be measured only for the initial test and after process or design changes which may affect capacitance.
 - d. Subgroup 7 tests sufficient to verify the truth table.
 - 4.3.2 Groups C and D inspections.
 - a. End-point electrical parameters shall be as specified in table II herein.
 - b. Steady-state life test (method 1005 of MIL-STD-883) conditions:
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_A = +125^{\circ}C$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by appendix B of MIL-M-38510 and method 1005 of MIL-STD-883.

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TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	
Final electrical test parameters (method 5004)	1*,2,9
Group A test requirements (method 5005)	1,2,3,4,7, 9,10,11**
Groups C and D end-point electrical parameters (method 5005)	1,2,3
 Additional electrical subgroups for group C periodic inspections	

PDA applies to subgroup 1.** Subgroups 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.

PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

6. NOTES

- 6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.
 - 6.2 Replaceability. Replaceability is determined as follows:
 - a. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
 - b. When a QPL source is established, the part numbered device specified in this drawing will be replaced by the microcircuit identified as part number M38510/65406--.
- 6.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone 513-296-5375.

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6.4 Approved sources of supply. Approved sources of supply are listed herein. Additional sources will be added as they become available. The vendors listed herein have agreed to this drawing and a certificate of compliance (see 3.5) has been submitted to DESC-ECS.

Military drawing part number	Vendor CAGE number	Vendor similar part number 1/	Replacement military specification part number
8512801RX	04713 27014 18714 01295	54HC573/BRAJC MM54HC573J/883 CD54HC573F/3A SNJ54HC573J	M38510/65406BRX
85128012X	04713 01295 27014	54HC573M/B2CJC SNJ54HC537FK MM54HC537E/883	M38510/65406B2X

 $\frac{1}{2}$ Caution: Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number	Vendor name and address			
01295	Texas Instrument, Inc. P.O. Box 6448 Midland, TX 79711			
04713	Motorola, Inc. 7402 South Price Road Tempe, AR 85283			
18714	RCA Corporation Solid State Division Route 202 Somerville, NJ 08876			
27014	National Semiconductor 2900 Semiconductor Drive P.O. Box 58090 Santa Clara, CA 95052-8090			

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